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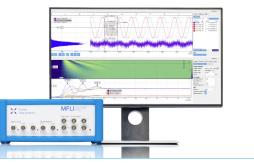
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ABSTRACT

Surface plasmon polaritons have rapidly established themselves as a promising concept for molecular sensing, near-field nanoimaging, and transmission lines for emerging integrated ultracompact photonic circuits. In this letter, we demonstrate a highly compact surface plasmon polariton detector based on an axial metal-semiconductor-metal nanowire heterostructure device. Here, an in-coupled surface plasmon polariton propagates along an aluminum nanowire waveguide joined to a high index germanium segment, which effectively acts as a photo-conductor at low bias. Based on this system, we experimentally verify surface plasmon propagation along monocrystalline Al nanowires as thin as 40 nm in diameters. Furthermore, the monolithic integration of plasmon generation, guiding, and detection enables us to examine the bending losses of kinked waveguides. These systematic investigations of ultrathin monocrystalline Al nanowires represent a general platform for the evaluation of nanoscale metal based waveguides for transmission lines of next generation high-speed ultracompact on-chip photonic circuits.

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The ever-increasing demand for more-compact and thus costeffective chemical sensing solutions anticipates a roadmap leading to a monolithic integration of optical components and functionalities into ultracompact integrated photonic circuits.^{1–7} Consequently, addressing demands with respect to operation speeds, efficiencies, and critical feature sizes rivaling electronics has triggered intense research interest in photonic components scaled beyond the diffraction limit of light.⁵ In this context, surface plasmon polaritons (SPPs), collective oscillations of electrons at metal-dielectric interfaces, constitute a promising concept, capable of concentrating and routing optical signals using subwavelength structures.^{8,9} Networks of kinked and branched nanowires (NWs) enable redirection of SPPs within a photonic circuit and thus support compact interferometric routing and logic operations.^{10–12} With respect to the waveguide material, unlike commonly used metals

for studying plasmonic effects such as Ag and Au, Al features unique material properties, enabling strong plasmon resonances ranging from the visible into ultraviolet.^{13,14} Thus, its natural abundance, chemical stability, low cost, and amenability to manufacturing processes and CMOS compatibility make Al a promising candidate for scalable plasmonic applications.^{13,15} However, propagation losses, radiation from leaky plasmon modes, and scattering by surface roughness are inevitable in realistic nanostructures.¹⁶ Hence, the geometry, structural size, and crystallinity of a NW waveguide are of crucial importance for plasmon propagation lengths.¹⁷ Direct imaging of SPP propagation along NWs is commonly accomplished by scanning near-field optical microscopy,^{17,18} limited to the spatial resolution of this optical method.¹⁰ Thus, in order to investigate the expected short propagation length of SPPs in ultrathin metallic NWs,^{10,19} we explored a near-field plasmon electrical detection

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scheme,²⁰ based on an axial metal-semiconductor-metal (M-S-M) NW heterostructure device architecture.

The Al-Ge-Al NW heterostructures were synthetized on 40 nm thick Si₃N₄ TEM-membranes²¹ by a thermally induced exchange reaction of single-crystalline Ge NWs covered by a passivating Al₂O₃ shell and lithographically defined Al contact pads [see Fig. 1(a) and the SEM image in the inset]. The NW growth and heterostructure device formation mechanism is discussed in the supplementary material and in detail in the former works of Kral et al.²² and El Hajraoui et al.²³ The single crystalline Al NW plasmonic waveguide and the Ge NW segment acting as an electronic plasmon detector are connected via an abrupt metal-semiconductor interface [see Fig. 1(b) and the supplementary material]. An efficient launching of SPPs along the Al NW is difficult to achieve due to the inherent size mismatch between the photonic and plasmonic modes. Here, plasmon excitation by phase-matching^{24,25} of the $\lambda = 532$ nm laser light to SPPs was achieved by an on-chip design of a focused diffraction grating coupler $(FGC)^{26,27}$ patterned in the Si₃N₄-TEM-membrane atop of the lithographically defined Al contacts using focused ion beam nanomachining [see Fig. 1(c)]. Unlike regular gratings supporting flat wave-fronts, an FGC generates converging wave-fronts, enabling improved coupling into the narrow NW waveguide.²⁸ The overall working principle is as follows: SPPs generated by the FGC patterned atop of the Al contact pads are guided along the c-Al NW plasmon waveguide acting also as an electrical contact of the Ge sensing element. At the Al-Ge interface, SPPs decay and generate excited carriers²⁹ in the adjacent Ge segment.²⁰ By applying a bias voltage (V_{Bias}) as shown in Fig. 1(a), these charge carriers induce a current proportional to the SPP intensity, enabling the detection of the plasmon signals by direct electric means. The length of the c-Al waveguide (L_{c-Al}) as well as the Ge segment (L_{Ge}) can be tuned by the contact gap (L) [see the SEM image in the inset of Fig. 1(a)] and the processing parameters, i.e., duration and temperature of the thermally induced exchange reaction. As shown in the supplementary material, the length of the c-Al section of a NW can be adjusted by successive annealing steps, enabling the investigation of SPP propagation for one and the same device as a function of the c-Al waveguide length.

To verify the working principle and the spectral responsivity of the device, a tunable laser was focused on the FGC while simultaneously measuring the current through the biased device. The plot in Fig. 2 shows the normalized current induced in the Ge segment by plasmons generated by excitation of the FGC with a laser wavelength between $\lambda = 480$ nm and 1100 nm (see the inset of Fig. 2). As the FGC was optimized for green laser light, a distinct maximum can be observed at about $\lambda = 532$ nm, as well as the second order peak around $\lambda = 1064$ nm.

To clarify the local origin of the plasmon induced current, the laser was scanned across the heterostructure device as indicated in the top panel of Fig. 3(a). The lower panel shows the corresponding current for the scanning laser being polarized perpendicular with respect to the NW axis. A distinct current peak further denoted I_{plas} appears when the laser matches the position of the FGC. SPPs generated at the FGC and effectively coupled into the c-Al NW generate excited carriers in the adjacent Ge segment, resulting in a bias dependent current.

Finite difference time domain (FDTD) simulations revealed that incident light with a polarization perpendicular to the grating couples best to the fundamental mode of the NW-membrane system, which is predominately TM polarized, i.e., in the y-direction [see mode electric field distributions in Fig. 3(b)]. The different plasmon mode contributions in the respective field polarization (x, y, z) are depicted in Fig. 3(b). The second peak appears when the laser beam directly illuminates the electrically biased Ge segment forming electron-hole pairs, resulting in a common photocurrent, denoted I_{pc} . Since there is no FGC incorporated at the opposite Al contact, the signal at this position equals the dark current.

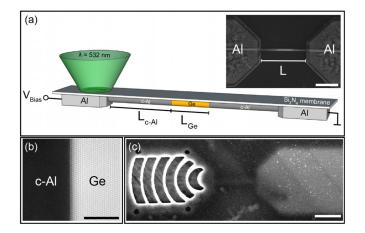


FIG. 1. (a) Schematic illustration of the AI-Ge-AI NW heterostructure device architecture fabricated on a 40 nm thick Si₃N₄-membrane. The SEM image (the scale bar is 1 μ m) in the inset shows the AI-Ge-AI NW heterostructure connected to macroscopic AI pads with a gap of about L = 2 μ m. (b) HRTEM image showing the atomically sharp and defect free AI-Ge heterojunction. The scale bar is 5 nm. (c) SEM image showing the FGC patterned in the Si₃N₄-membrane atop of the lithographically defined AI contacts. The scale bar is 1 μ m.

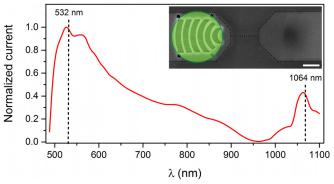


FIG. 2. Spectral responsivity of the FGC excited by a tunable laser, operating in the wavelength range between $\lambda=480\,\text{nm}$ and 1100 nm, while simultaneously biasing the device with $V_{\text{Bias}}=100\,\text{mV}$. The diameter and length of the c-AI NW waveguide attached to the FGC were 40 nm and 700 nm, respectively. The measurement was conducted at room temperature and ambient conditions, and the data were corrected with respect to the wavelength dependent laser output power. The SEM image in the inset shows the overall contact arrangement of the AI-Ge-AI NW heterostructure device. The scale bar is 1 μm . The green spot indicates the laser position for exciting the FGC by the tunable laser.

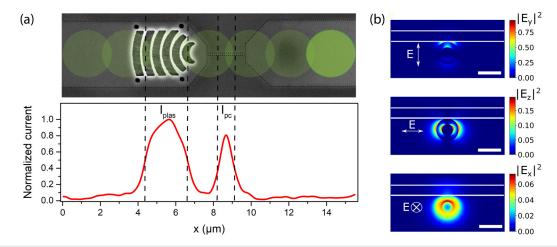


FIG. 3. (a) The upper panel shows an SEM image of the contact arrangement of the AI-Ge-AI NW heterostructure device with the FGC patterned atop of the left lithographically defined AI contact with superimposed grating and beam contours. The lower panel shows the respective line scan across the device starting from the FGC contact toward the opposite contact measuring both the plasmon induced current and photocurrent for TM polarized laser excitation ($V_{Bias} = 100 \text{ mV}$). (b) FDTD simulations of the electric field intensity for the $|E_y|^2$, $|E_z|^2$, and $|E_x|^2$ field distributions of the fundamental mode in the NW-Si₃N₄ membrane system. The scale bar is 60 nm; the white arrows indicate the predominant field polarization, and the white lines are the contours of the membrane.

The FGC plasmon generator in combination with the extremely sensitive near-field electrical Al-Ge-Al plasmon detector device allows the propagation length of SPPs in ultrathin c-Al NW waveguides to be measured with a high spatial resolution. Figure 4(a) shows the plasmon induced currents for devices with various lengths of the c-Al SPP waveguides (L_{c-Al}) between 450 nm and 1085 nm [see the inset of Fig. 4(a)]. Assuming that I_{plas} is directly correlated with the SPP intensity, a decrease in more than two orders of magnitude for an only 600 nm long waveguide indicates extreme damping for such ultrathin Al NWs. The exponential fit of the experimental data reveals a propagation length of L_{SPP} = 140 nm. Based on FDTD simulations, an imaginary part of the effective refractive index of the fundamental mode in the c-Al NW of $\Im(n_{\text{eff.}}) \approx 0.3$ at $\lambda = 532$ nm was extracted from which a propagation length of L_{SPP,calc.} = $\frac{\lambda}{4\pi\Im(n_{\text{eff.}})} = 141$ nm

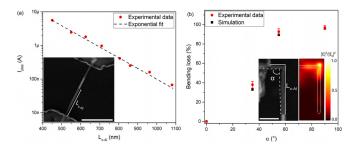


FIG. 4. (a) Plasmon induced current as a function of the length L_{c-Al} of the c-Al waveguide. The inset shows an SEM image of a heterostructure device with an indicated length of the c-Al waveguide of L_{c-Al} = 950 nm. The scale bar is 1 μ m. (b) Experimentally determined and calculated bending losses depending on the kinking angle α for the M-S-M devices with an overall c-Al waveguide length of L_{c-Al} \approx 700 nm. The left inset shows the SEM image of a device with a 90° kinked c-Al plasmon waveguide. The scale bar is 200 nm. The right inset shows the respective FDTD simulation plot. All measurements were conducted for V_{Blas} = 100 mV, E_L = 340 μ W/ μ m², and λ = 532 nm at room temperature and ambient conditions.

could be calculated. In the simulation, an ultrathin Ge shell originating from the fabrication process and surrounding the Al NW was also taken into account, which is consistent with the TEM analysis provided by El Hajraoui *et al.*²³

Thus, although the investigated Al NWs are monocrystalline and rodlike with a smooth surface,³⁰ the confinement of SPPs in such ultrathin NWs results in high propagation loss,¹⁶ limiting the transmission length for on-chip communication even for straight NWs. However, simulations show that a manifold enhancement of the SPP propagation length can be achieved by tuning the NW diameter.³¹ For our system, an increased Al NW diameter of 100 nm would lead to a propagation length of 470 nm. Simulations showing the dependency of the diameter of the c-Al NW waveguides on the SPP propagation length are provided in the supplementary material. Future high-speed ultracompact photonic components will require waveguide bends capable of redirecting signals within a circuit with minimum footprint and as little losses as possible.^{10,16} In order to investigate such broken symmetry waveguides,¹⁰ kinked c-Al SPP waveguides with an overall length of $L_{c-Al} \approx 700$ nm exhibiting approximately zero radius of curvature and inclination angles between $\alpha = 0^{\circ}$ and 90° were integrated in the M-S-M devices. The inset in Fig. 4(b) shows an SEM image and the FDTD simulation plot of an exemplarily device with a 90° inclined c-Al plasmon waveguide. Additional SEM-images showing heterostructure devices with 35° and 55° inclined c-Al plasmon waveguides are displayed in the supplementary material. The disturbance of SPP propagation at the kink is clearly observable in the simulation plot. Propagating SPPs are effectively scattered into radiating photons at the kink, resulting in a drop of the transmitted power.^{16,32,} ³ By calculating the electric fields at the end facet of the 700 nm long c-Al NW, the resultant bending losses were determined to be 33%, 89%, and 96% for kink angles of $\alpha = 35^{\circ}$, 55° , and 90° , respectively.

Experimentally, due to the enhanced scattering at the kinks, less plasmons pass the 700 nm long c-Al NW on their way to the Al-Ge interface. The plasmon induced current thus decreases with increasing kinking angles. The measured bending losses shown in the main plot of Fig. 4(b) are in reasonable agreement with the simulated values. The shown data points correspond to the mean values over three devices for each of the investigated kink-angles. This clearly demonstrates that bending losses in ultrathin metal waveguides are a crucial factor for the design of transmission lines within ultracompact photonic circuits.

In conclusion, we have demonstrated the effective coupling and guiding of light over ultrathin c-Al NWs. To measure the plasmonic propagation characteristics, we explored an extremely sensitive near-field electrical plasmon detector based on an axial Al-Ge-Al NW heterostructure. Plasmon excitation by phase-matching light to SPPs was achieved by FGCs tuned for an excitation wavelength of λ = 532 nm. Based on this system, we experimentally determined a propagation length of L_{SPP} = 140 nm for the confined SPPs in monocrystal-line 40 nm thin Al NWs. Most notably, with respect to waveguide bends required for on-chip routing of signals within photonic networks, we assessed the bending losses for kinked c-Al NWs. Thus, our monolithic approach is an important step toward highly efficient plasmon sensing applications that eliminate the need for far-field detection.

See the supplementary material for Ge NW synthesis, device fabrication, and electrical and optical device characterization; detailed description of a HRTEM image recorded at the Al-Ge interface; discussion of the approach to control the length of the c-Al NWs and the respective change of the plasmon induced currents by successive thermal annealing; images of devices with 35°, 55°, and 90° inclined c-Al plasmon waveguides; and simulations showing the dependency of the diameter of the c-Al NW waveguides on the SPP propagation length.

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